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## **<u>MOSFET</u> – Power, Single N-Channel** 40 V, 3.5 mΩ, 101 A

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



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V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
40 V	3.5 mΩ @ 10 V	101 A

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V <sub>DSS</sub>	40	V	
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V	
Continuous Drain Cur-	Steady State	$T_{C} = 25^{\circ}C$	۱ <sub>D</sub>	101	А	
rent $R_{\theta JC}$ (Notes 1 & 3)		$T_{C} = 100^{\circ}C$		71		
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	PD	101	W	
		$T_{C} = 100^{\circ}C$		33		
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2 & 3)	Steady State	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	22	А	
		T <sub>A</sub> = 100°C		18		
Power Dissipation $R_{\theta JA}$		$T_A = 25^{\circ}C$	PD	3.1	W	
(Notes 1 & 2)		$T_A = 100^{\circ}C$		2.2		
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I <sub>DM</sub>	590	А	
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to 175	°C	
Source Current (Body Diode)			ا <sub>S</sub>	73	А	
Single Pulse Drain-to-Source Avalanche Energy ( $T_J$ = 25°C, $I_{L(pk)}$ = 11 A)			E <sub>AS</sub>	214	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

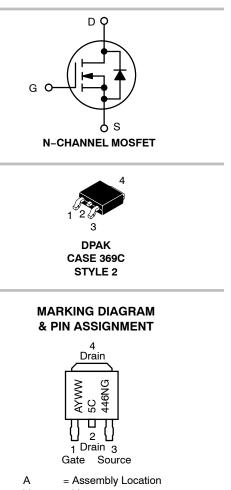
#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{\theta JC}$	2.28	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	48	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



Y = Year WW = Work Week 5C446N = Device Code G = Pb-Free Package

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

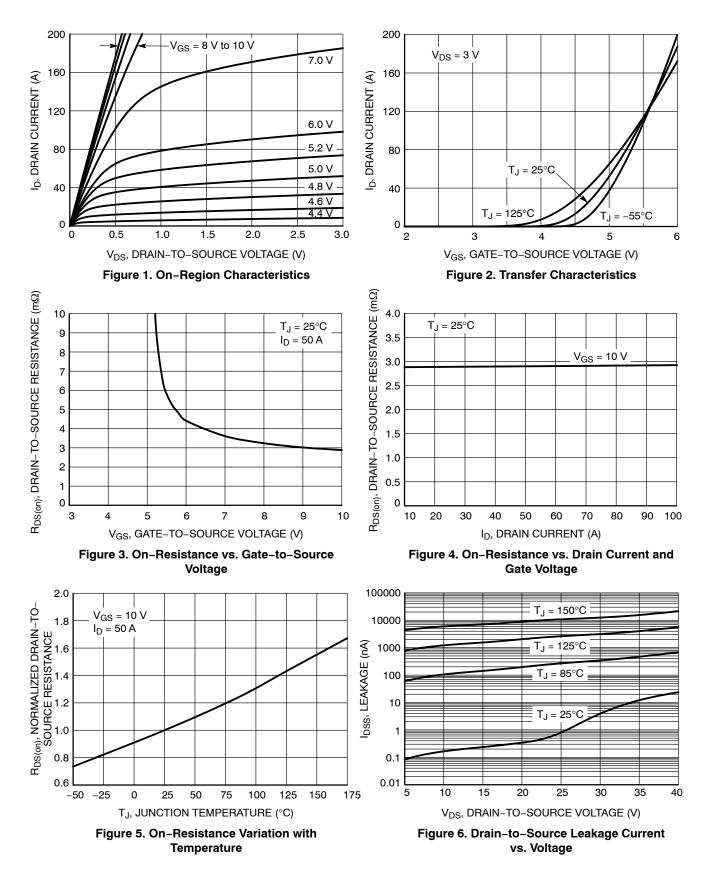
Downloaded from Arrow.com.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

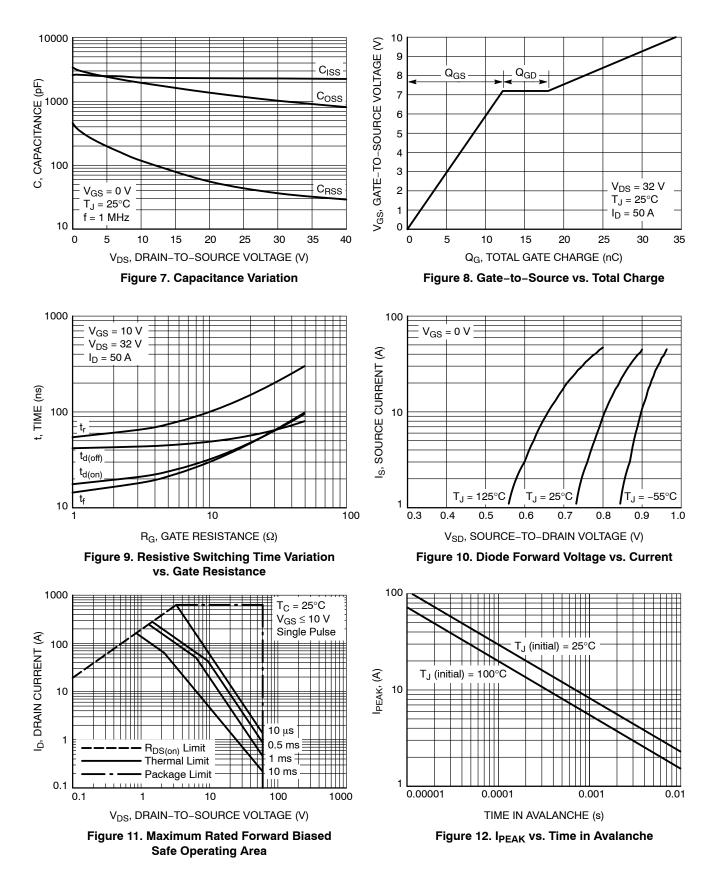
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS						-	
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				19		mV/°C
Zero Gate Voltage Drain Current	$I_{DSS}$ $V_{GS} = 0 V$ , $T_J = 25^{\circ}C$		$T_J = 25^{\circ}C$			10	μΑ
		$V_{DS} = 40 V$	T <sub>J</sub> = 125°C			250	-
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	= 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				7.5		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50 A			2.9	3.5	mΩ
Forward Transconductance	9FS	V <sub>DS</sub> = 3 V, I <sub>D</sub> = 50 A			100		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES					-	
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 25 V			2300		pF
Output Capacitance	C <sub>oss</sub>				1200		
Reverse Transfer Capacitance	C <sub>rss</sub>				46		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 32 V, I <sub>D</sub> = 50 A			34.3		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>				5.0		
Gate-to-Source Charge	Q <sub>GS</sub>				12.2		
Gate-to-Drain Charge	Q <sub>GD</sub>				5.8		1
Plateau Voltage	V <sub>GP</sub>				7.2		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t <sub>d(on)</sub>				20		ns
Rise Time	t <sub>r</sub>	Vcs = 10 V. Vp	s = 32 V.		62		1
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 32 V, I <sub>D</sub> = 50 A, R <sub>G</sub> = 2.5 Ω			43		1
Fall Time	t <sub>f</sub>				17		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S				•		
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.9	1.2	V
		$I_{\rm S} = 50 \rm{A}$	T <sub>J</sub> = 125°C		0.8		1
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dls/dt = 100 A/μs, I <sub>S</sub> = 50 A			46		ns
Charge Time	ta				23		1
Discharge Time	tb				23		1
Reverse Recovery Charge	Q <sub>RR</sub>				40		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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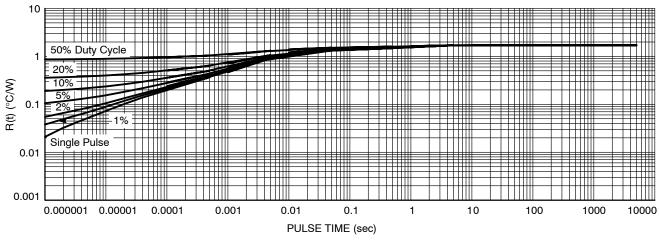


Figure 13. Thermal Characteristics

#### **ORDERING INFORMATION**

Order Number	Package	Shipping <sup>†</sup>
NVD5C446NT4G	DPAK (Pb–Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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